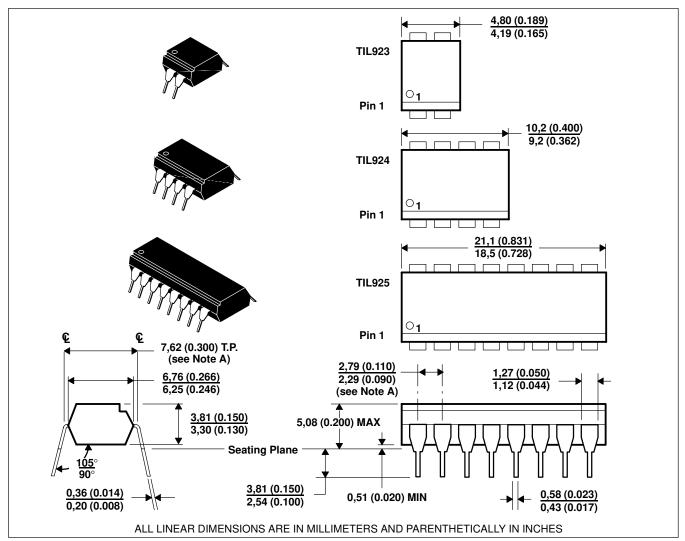
- Gallium-Arsenide Diode Infrared Source
- Source Is Optically Coupled to Silicon N-P-N Darlington Phototransistor
- Choice of One, Two, or Four Channels
- Choice of Two Current-Transfer Ratios
- High-Voltage Electrical Isolation . . . 7.5 kV Peak (5.3 kV rms)
- Plastic Dual-In-Line Packages
- UL Listed File No. E65085

### description

These optocouplers consist of a gallium-arsenide light-emitting diode and a silicon n-p-n Darlington phototransistor per channel. The TIL923 has one channel in a 4-pin package, the TIL924 has two channels in a 8-pin package, and the TIL925 has four channels in a 16-pin package. The standard devices, TIL923, TIL924, and TIL925, are tested for a current-transfer ratio of 500% minimum. Devices selected for a current-transfer ratio of 1000% are designated with the suffix.

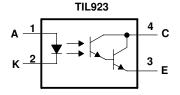
### mechanical data

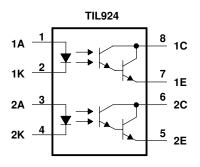


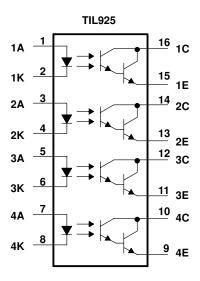
NOTE A: Each pin centerline is located 0,25 (0.010) of its true longitudinal position.



## schematic diagrams







## absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)

Input-to-output voltage (see Note 1)±7.5 kV peak or of	dc (±5.3 kV rms)
Collector-emitter voltage (see Note 2)	35 V
Emitter-collector voltage	7 V
Input diode reverse voltage	5 V
Input diode continuous forward current at (or below) 25°C free-air temperature (see Note 3)	50 mA
Continuous power dissipation at (or below) 25°C free-air temperature:	
Phototransistor (see Note 4)	150 mW
Input diode plus phototransistor per channel (see Note 5)	200 mW
Operating free-air temperature, T <sub>A</sub>	−55°C to 100°C
Storage temperature range	-55°C to 125°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

NOTES: 1. This rating applies for sine-wave operation at 50 or 60 Hz. Service capability is verified by testing in accordance with UL requirements.

- 2. This value applies when the base-emitter diode is open circuited.
- 3. Derate linearly to 100°C free-air temperature at the rate of 0.67 mA/°C.
- 4. Derate linearly to 100°C free-air temperature at the rate of 2 mW/°C.
- 5. Derate linearly to 100°C free-air temperature at the rate of 2.67 mW/°C.

## electrical characteristics, T<sub>A</sub> = 25°C (unless otherwise noted)

PARAMETER			TEST	MIN	TYP	MAX	UNIT		
V <sub>(BR)</sub> CEO	O Collector-emitter breakdown voltage		$I_C = 0.5 \text{ mA},$	lF = 0		35			V
V <sub>(BR)ECO</sub>	CO Emitter-collector breakdown voltage		$I_C = 100  \mu A$ ,	lF = 0		7			V
IR	IR Input diode static reverse current		V <sub>R</sub> = 5 V					10	μΑ
IC(off)	Off-state colle	ctor current	V <sub>CE</sub> = 10 V,	lF = 0				100	nA
CTR	Current	Surrent TIL923, TIL924, TIL925			500%				
CIN	transfer ratio	TIL923A, TIL924A, TIL925A	$I_F = 2 \text{ mA},$	V <sub>CE</sub> = 1 V		1000%			
٧F	Input diode sta	atic forward voltage	I <sub>F</sub> = 20 mA				1.4	V	
V <sub>CE(sat)</sub>	/CE(sat) Collector-emitter saturation voltage		IF = 10 mA,	$I_C = 50 \text{ mA}$				1	V
C <sub>io</sub>	Input-to-output capacitance		$V_{in-out} = 0$ ,	f = 1 MHz,	See Note 6		1		pF
r <sub>io</sub>	Input-to-output internal resistance		$V_{in-out} = \pm 1 \text{ kV},$	See Note 6			1011		Ω

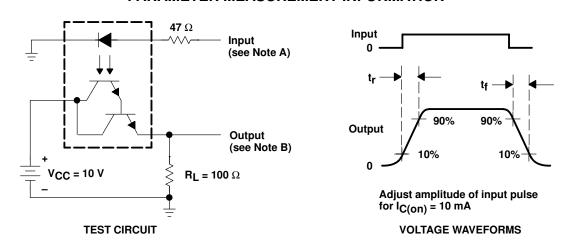
NOTE 6. These parameters are measured between all input-diode leads shorted together and all phototransistor leads shorted together.



## switching characteristics at 25°C free-air temperature

	PARAMETER		MIN	TYP	MAX	UNIT		
t <sub>r</sub>	Rise time	V 10 V	$I_{C(on)} = 10 \text{ mA}, R_{I} = 100 \Omega,$	See Figure 1		100		
t <sub>f</sub>	Fall time	$V_{CC} = 10 \text{ V},$	$I_{C(on)} = 10 \text{ mA}, R_L = 100 \Omega,$	See Figure 1		100		μs

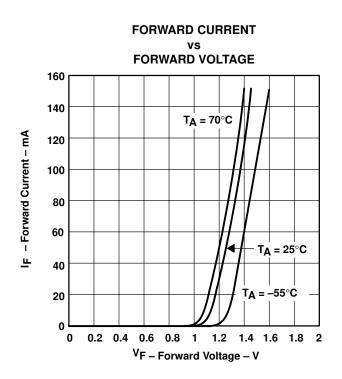
### PARAMETER MEASUREMENT INFORMATION

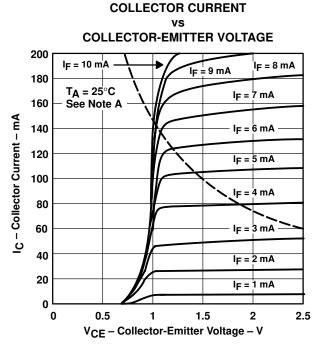


NOTES: A. The input waveform is supplied by a generator with the following characteristics:  $Z_0 = 50 \,\Omega$ ,  $t_r \le 15 \,\text{ns}$ , duty cycle = 1%,  $t_W = 500 \,\mu\text{s}$ . B. The output waveform is monitored on an oscilloscope with the following characteristics:  $t_r \le 12 \,\text{ns}$ ,  $R_{in} \ge 1 \,\text{M}\Omega$ ,  $C_{in} \le 20 \,\text{pF}$ .

Figure 1. Switching Times

### TYPICAL CHARACTERISTICS

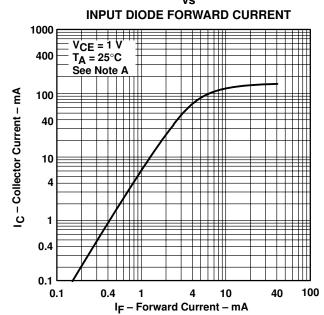




NOTE A: Pulse operation is required for operation beyond limits shown by the dashed line.

Figure 2 Figure 3

## COLLECTOR CURRENT



NOTE A: These parameters are measured using pulse techniques  $t_{W}=1 \ ms, \ duty \ cycle \leq 2\%.$ 

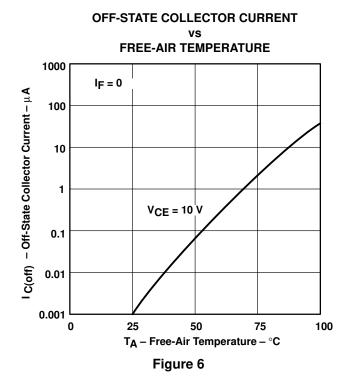
Figure 4



### TYPICAL CHARACTERISTICS

## **RELATIVE ON-STATE COLLECTOR CURRENT** FREE-AIR TEMPERATURE 1.2 Collector Current Relative to Value at TA = 25 $^{\circ}\text{C}$ V<sub>CE</sub> = 1 V IF = 10 mA IF = 2 mA 0.8 I<sub>F</sub> = 10 mA 0.6 0.4 IF = 2 mA 0.2 25 -75 -50 -25 75 100 T<sub>A</sub> - Free-Air Temperature - °C

Figure 5







ti.com 8-Apr-2005

### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
TIL923	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI
TIL923A	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI
TIL924	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI
TIL924A	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI
TIL925	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI
TIL925A	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

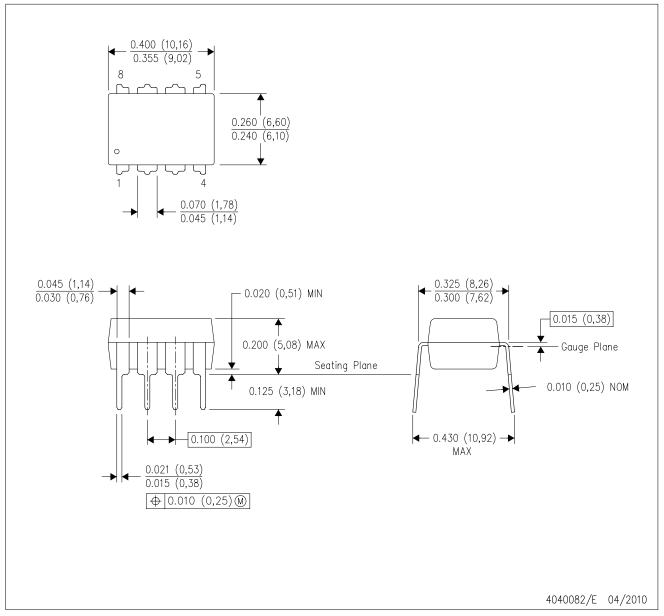
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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# P (R-PDIP-T8)

## PLASTIC DUAL-IN-LINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



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